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2SC535

Silicon NPN Epitaxial Planar

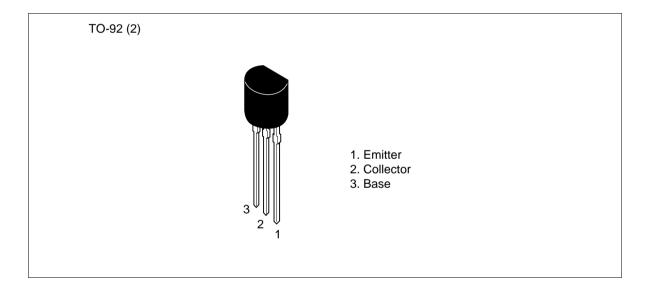


ADE-208-1047 (Z) 1st. Edition Mar. 2001

Application

VHF amplifier, mixer, local oscillator

Outline



2SC535

Absolute Maximum Ratings $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{\scriptscriptstyle \sf CBO}$	30	V
Collector to emitter voltage	V_{CEO}	20	V
Emitter to base voltage	V_{EBO}	4	V
Collector current	I _c	20	mA
Collector power dissipation	P _c	100	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

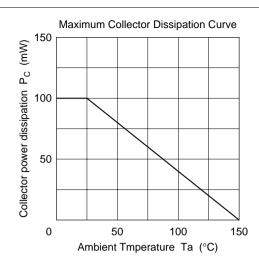
Electrical Characteristics ($Ta = 25^{\circ}C$)

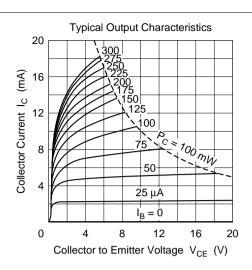
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	_	_	V	$I_{\rm C} = 10 \ \mu A, \ I_{\rm E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	20	_	_	V	$I_{C} = 1 \text{ mA}, R_{BE} =$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	4	_	_	V	$I_{E} = 10 \ \mu\text{A}, \ I_{C} = 0$
Collector cutoff current	I _{CBO}	_	_	0.5	μA	$V_{CB} = 10 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE} *1	60	_	200		$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA}$
Base to emitter voltage	V_{BE}	_	0.72	_	V	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	0.17	_	V	$I_C = 20 \text{ mA}, I_B = 4 \text{ mA}$
Gain bandwidth product	f _T	450	940	_	MHz	$V_{CE} = 6 \text{ V}, I_{C} = 5 \text{ mA}$
Collector output capacitance	Cob	_	0.9	1.2	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Power gain	PG	17	20	_	dB	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA},$ f = 100 MHz
Noise figure	NF	_	3.5	5.5	dB	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA},$ $f = 100 \text{ MHz}, R_{g} = 50 \Omega$
Input admittance (typ)	yie	1.3 + j5.3		mS	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA},$ f = 100 MHz	
Reverse transfer admittance (typ)	yre	-0.078 - j0.41		mS		
Foward transfer admittance (typ)	yfe	32 – j1	0		mS	_
Output admittance (typ)	yoe	0.08 +	j0.82		mS	

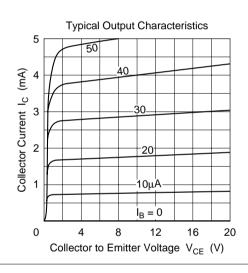
Note: 1. The 2SC535 is grouped by $h_{\mbox{\tiny FE}}$ as follows.

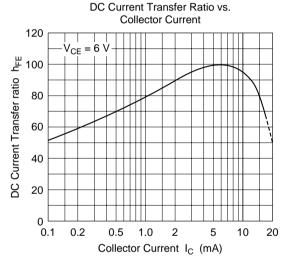
В	С
60 to 120	100 to 200

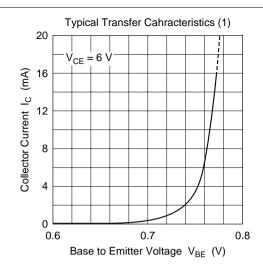
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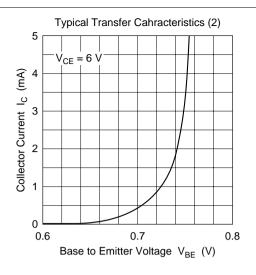


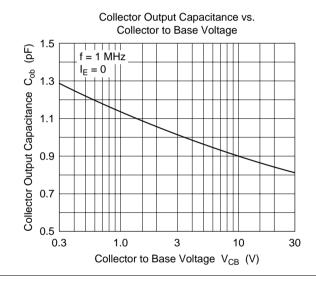


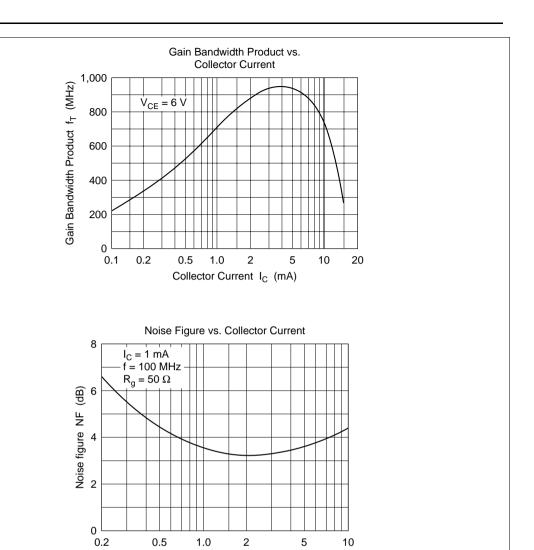




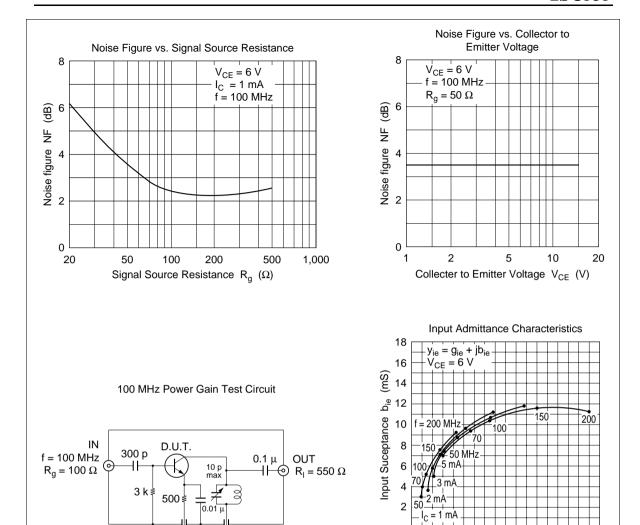








Collector Current I_C (mA)



Unit $R:\Omega$

C: F

 V_{EE}

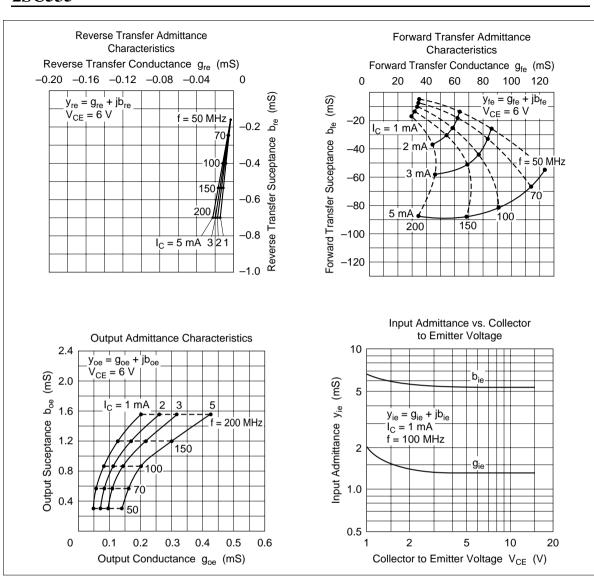
 V_{CC}

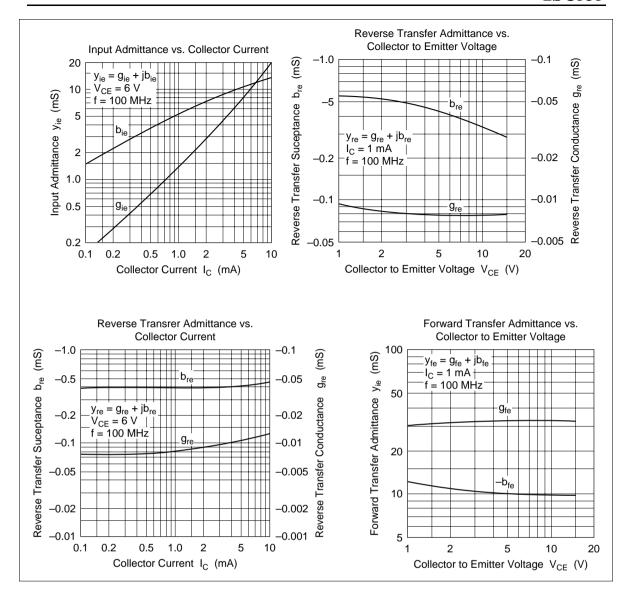
0

6 8 10 12

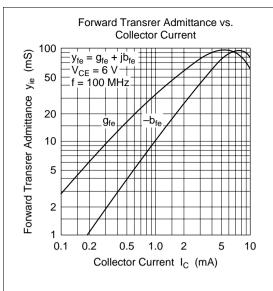
Input Conductance gie (mS)

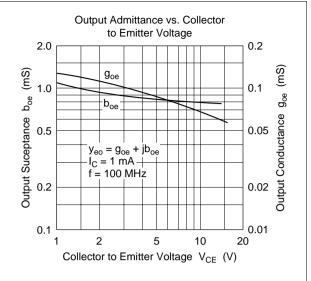
14 16 18

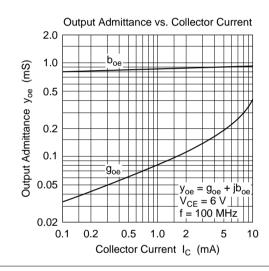




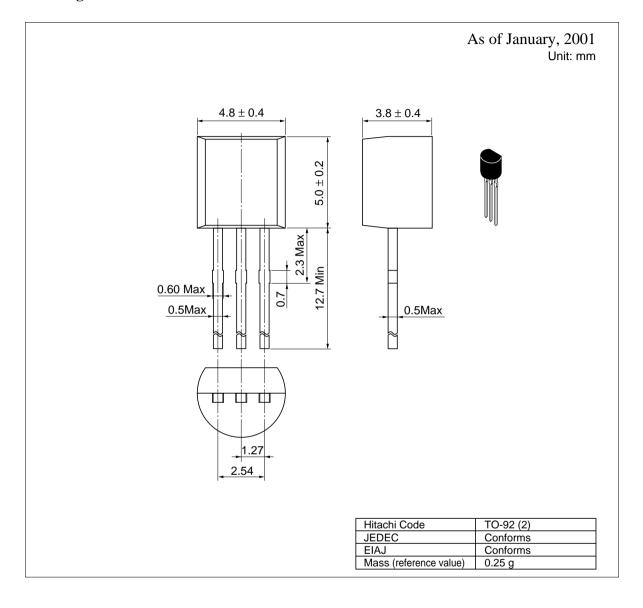
2SC535







Package Dimensions



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